

28C64B

64K (8K x 8) CMOS Electrically Erasable PROM

FEATURES

- High Speed Performance 70, 90, 120, 150, 200, 250ns Access Time
- CMOS Technology for Low Power Dissipation - 70mA Active
- 150µA Standby
- Fast Write Cycle Times
- 64-Byte Page Write Operation
- Page or Byte Write Cycle 2ms
- Average Byte Write Time 31µs
- High Endurance/Retention
- 10⁴ Erase/Write Cycles
- >10 Years Data Retention
- JEDEC-Approved
- Byte Wide Pinout, 28 Pin DIP or 32 Pin Chip Carrier
- Hardware Chip Clear
- Hardware Data Protection
- Software Data Protection
- Write Operation Status
- RDY/BSY
- Data Polling
- Toggle Bit
- Software Data Protection Status Available in Extended Temperature Range:
- Commercial: 0°C to +70°C - Industrial; -40°C to +85°C
- Military *: -55°C to +125°C

DESCRIPTION

The Microchip Technology Inc. 28C64B is a CMOS 64K bit Electrically Erasable and Programmable Read only Memory. The device is organized as 8K words by 8 bits (8K bytes). An advanced CMOS design and process provides high speed while reducing power requirements. This very high speed device allows the most sophisticated microprocessors to run at full speed without the need for wait states.

The 28C64B is accessed like a static RAM for the read or write cycle without the need of external components. During a write operation, the address and 1 to 64 bytes of data are latched internally, freeing the microprocessor address and data bus for other operation. Following the initiation of a write cycle, the device will go to a busy state and automatically clear and write the latched data using an internal control timer. The completion of a write cycle is detected by either Data polling of output (I/O7) or the Toggle Bit (I/O6).





PRELIMINARY INFORMATION

2-57

© 1990 Microchip Technology Inc. DS11120A-1



Name	Function					
A0-A12	Address Inputs					
CE	Chip Enable					
ŌĔ	Output Enable					
WE	Write Enable					
I/O0-I/O7	Data Input/Output					
Vcc	+5V					
Vss	Ground					
NC	No Connection: no internal connection					
NU	Not used: no external connection is allowed					

DC CHARACTERISTICS

ELECTRICAL CHARACTERISTICS

Maximum Ratings*

 $Vcc = +5V \pm 10\%$

Vcc and Input Voltage W.R.T. Vss	0.6V to 6.25V
All Output Voltage W.R.T. Vss	
Voltage of OE W.R.T. Vss	0.6V to 13.5V
Temperature Under Bias,	-55°C to +125°C
Storage Temperature	

*Notice: Stresses above those listed under "Maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS	TAMB: Commercial: 0°C to +70°C Industrial: -40°C to +85°C						
Parameter	Status	Symbol	Min	Max	Units	Conditions	
Input Voltages	Logic "1" Logic "0"	ViH ViL	2.0 -0.1	Vcc +1 0.8	< <	-	
Input Leakage		lu	-10	10	μA	VIN = 0V to Vcc +1.0V	
Input Capacitance		Cı	-	10	pF	Vin = 0V; Тамв = 25°С; f = 1MHz	
Output Voltages	Logic "1" Logic "0"	Vон Vo∟	2.4	0.45	v v	ίοη = -400μΑ ίοι = 2.1mA	
Output Leakage		ILO	-10	10	μA	Vour = 0 to Vcc	
Output Capacitance		Со	-	10	рF	Vout = 0V; TAMB = 25°C; f = 1MHz	
Address and Control Capacitance		Cin	-	6	рF	Vin = 0V; Tamb = 25°C; f = 1MHz	
Power Supply Current, Active	TTL Input	ICC1	-	70	mA	TAMB = 0°C to 70°C; TAMB = -40°C to 85°C; other conditions: VCC = 5.5V, max frequency $\overline{OE} = \overline{CE} = VIL, IOUT = 0mA,$ VIL = -0.1V to 0.8V VIH = 2.0V to VCC	
Power Supply Current, Standby	TTL Input CMOS Input	ICC(s)1 ICC(s)3	-	1 150	mA μA	TAMB = 0°C to 70°C; $\overline{CE} = VIH$ TAMB = -40°C to 85°C; $\overline{CE} = VIH$ all TAMB; $\overline{CE} = Vcc \pm 0.2V$	

DS11120A-2

2-58

© 1990 Microchip Technology Inc.

15-61

READ OPERATION AC Characteristics	O In	Testing Waveform: Output Load: Input Rise and Fall Times: Ambient Temperature:					VIH = 2.4V; VIL = 0.45V; VOH = 2.0V; VOL = 0.8V 1 TTL Load + 100pF 20 nsec Commercial: TAMB = 0°C to +70°C Industrial: TAMB = -40°C to +85°C						+70°C		
		28C64B-70		28C64B-90 28C		28C64	C64B-12 28C64B-1		4B-15	5 28C64B-20		28C64B-25			
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Units	Test :
Read Cycle Time	tRC	70	-	90	•	120	-	150	-	200	•	250	•	ns	:
Address to Output Delay	tacc	-	70	-	90		120	-	150	-	200	-	250	ns	CE = OE = VIL
CE to Output Delay	tCE	-	70	-	90	-	120	•	150	-	200	-	250	ns	ÕE ≈ VIL
OE to O/P Delay	tOE	0	35	0	40,	0 -	50	0	70	0	80	0	100	ns	ÕË = VIL
CE or OE to O/P Float	tOFF	0	35	0	40	0	50	0	65	0	70	0	70	пs	
Output Hold From Address, CE or OE, whichever occurs first	tон	0	-	0	•	0	•	0		0	•	0	-	ns	

2

.....



© 1990 Microchip Technology Inc.

1

2-59

DS11120A-3

BYTE WRITE AC Characteristics	Output Lo Input Rise	Vaveform: bad: and Fall 1 Temperatu		VIH = 2.4V; VIL = 0.45V; VOH = 2.0V; VOL = 1 TTL Load + 100pF 20 nsec Commercial: ТАМВ = 0°С to +70°С Industrial: ТАМВ = -40°С to +85°С				
		28C256 - 90/12/15/20/25						
Parameter	Parameter Symbol Min Typ Ma) Max	Units	Conditions			
Write Cycle Time	twc	-	1	2	ms	-		
Byte Write Cycle Time	tewo	-	1	2	ms	(see Note 3)		
Address Set-Up Time	tas	0	-	-	ns	•		
Address Hold Time	, tAH	50	-	-	ns	-		
OE Set-Up Time	tOES	0	-	-	ns	-		
OE Hold Time	tOEH	0	-	-	ns	-		
Data Set-Up Time	tos	50		-	ns	-		
Data Hold Time	T tDH	0	-	-	ns	-		
Write Pulse Width	tŵP	100	-	-	ns	·		
Byte Load Timer Cycle	tBLC	0.1	-	150	μs	(see Note 5)		
Byte Loading Period	tLP -	100	-	-	ns	(see Note 4)		



DS11120A-4

2-60

© 1990 Microchip Technology Inc.

PAGE WRITE WAVEFORM ٧н ADDRESS VALID VALID DON'T CARE VALIC Va. tag LP(4) Vii ĈĒ Vit **IOEH IOE**S VIF ÖE VH BLC(5 twc(3) ViF WE ViL Vit l/Os Va DATA DATA DATA DATA POLLING DO DI Dn

2

1-40-13-21

DEVICE OPERATION

The Microchip Technology Inc. 28C64B has five basic modes of operation - read, standby, page or byte write, write inhibit and chip clear - as outlined in the following table.

Operation	CE	ŌĒ	WE	VO		
Read	VIL	VIL	ViH	Dout		
Standby	ViH	X(1)	x	High Z		
Write (2) - Byte/Page Write Inhibit) age ♀ V⊮		Q x	DIN High Z/Dout		
Write Inhibit Write Inhibit Chip Clear (3)	V⊪ X V⊧L	X X VH	x V⊮ Ø	High Z High Z/Dour High Z		
(2) R (3) R (4) Q	efer to "Ch	ogramming tip Clear W going puls	aveforms'			

<u>Read</u>

The read is initiated by presenting a stable address to the memory along with \overline{WE} as high, \overline{CE} as low and \overline{OE} as low. The outputs are put in a high impedance state whenever \overline{CE} or \overline{OE} is high. This dual line control gives designers increased flexibility in preventing bus contention.

© 1990 Microchip Technology Inc.

Byte Write

The byte write is initiated when \overline{CE} and \overline{WE} are low and \overline{OE} is high. The address is latched on the falling edge of either \overline{CE} or \overline{WE} , whichever occurs last. The write data is latched on the rising edge of either \overline{CE} or \overline{WE} , whichever occurs first. The 28C64B performs an auto clear before write. After tLP the write operation status bits are available and the \overline{CE} , \overline{WE} and \overline{OE} signals may be removed.

Page Write

The page write allows 2 to 64 bytes of data to be written into the 28C64B in one internal programming cycle. Internally, there are 64 byte registers (one page) addressed by A0 through A5. Data is loaded into corresponding registers during the loading period and all data will be written into the specified page of memory at once. Each successive byte load cycles, started by the falling edge of WE or CE, whichever occurs last, must begin within 150µs from the rising edge of the preceding write control signal (WE or CE). Otherwise, the loading period ends and the internal programming cycle starts. If page address (A6 through A12) does not stay the same through the entire loading period, all data loaded will be written into the page address of the last data written. Only those bytes which have been loaded will be programmed. The unselected bytes in the page will not receive a programming cycle, and thus the endurance of the array is preserved. After tBLP the write operation status bits are available and the CE, WE and OE signals may be removed.

2-61

DS11120A-5

Write Operation Status Bits

The 28C64 provides the user four write operation status bits. RDY/BSY pin is used for write cycle status, I/O7 is used for Data Polling. I/O6 is used as a Toggle Bit, and I/O3 is used for software data protect status bit.

Data Polling: During the write loading period and the internal programming cycle and attempted read results in the complementary of the last data on I/O7. Once the internal programming cycle is completed, true data is available.

RDY/BSY: The 28C64B has a write cycle similar to that of a Static RAM. The write cycle is completely self-timed and initiated by a low going pulse on the \overline{WE} pin. On the falling edge of \overline{WE} , the address information is latched. On rising edge, the data and the control pins (\overline{CE} and \overline{OE}) are latched. The Ready/Busy pin goes to a logic low level indicating that the 28C64B is in a write cycle which signals the microprocessor host that the system bus is free for other activity. When Ready/Busy goes back to a high, the 28C64B has completed writing and is ready to accept another cycle.

Toggle Bit: During the write loading and the internal programming cycle I/O6 will toggle on each attempted read. The first read value is "0". The toggle operation will cease after completion of the internal programming cycle.

Page Load Timer (I/O5)

During the write loading period and internal programing cycle, I/O5 will show the page-load timer status on read operation. "O" means it is still in the loading window. "i" tells the user that the loading period has expired and the internal programming cycle has begun.



Software Data Protect Status Bit: During the write loading period and internal programming cycle I/O3 will show either a "1", meaning the chip is software data protected or a "0", meaning the chip is not in the software data protection mode.

Hardware Data Protection

The 28C64B offers protection against inadvertent write operations by the following hardware features: (1) if VCC is below 3 volts the write operation is inhibited; (2) after VCC is above 3.8 volts, the 28C64B will automatically wait 5ms until a write operation is allowed; (3) a filter circuit on \overline{WE} or \overline{CE} prevents pulses of less than 20ns duration from initiating a write cycle; and (4) holding \overline{WE} or \overline{CE} low inhibits a write cycle.

Software Data Protection

The 28C64B offers a software-controlled data protection feature. Once software data protection is employed, the 28C64B is automatically protected during power-up or power-down without the need for external circuitry. The 28C64B is further protected from inadvertent and accidental writes in the power on state. Setting the software data protection mode requires a series of three bytes of data to be written consecutively into three specific addresses. The write sequence must conform to the page write timing specifications. Figure 1 shows the sequence of setting the software data protect mode. The third byte of the algorithm effectively opens the page write window to enable up to 64 bytes of data to be written. Once the internal programming cycle is complete, the 28C64B will automatically be returned to the software data protection state. Addition writes into a protected device requires the complete software data protection setting sequence to be executed. The soft-



DS11120A-6

2-62

© 1990 Microchip Technology Inc.

🖬 6103201 0004762 O 🖿

MICROCHIP TECHNOLOGY INC

ware data protection circuit can be reset by performing a series of six byte writes as shown in Figure 2. Page writing is allowed immediately after the sixth write of the reset algorithm.

Hardware Chip Clear

he 28C64B array is cleared to all "1"s by raising \overrightarrow{OE} to 12V and setting \overrightarrow{CE} to VIL and then bringing the \overrightarrow{WE} to VIL. See Figure 3.



Software Chip Clear

55E · D ;

The 28C64B also provides a software-controlled chip clear feature. The memory can be cleared by issuing a series of six-byte codes to specific addresses. The software chip clear algorithm is shown in Figure 4. The software chip clear functions only when write protection is reset. During the 10ms chip clear cycle, both data polling and toggle bit features can be used to detect the internal programming status.

T-46-13-27





© 1990 Microchip Technology Inc.

2-63

DS11120A-7

SALES AND SUPPORT

.

To order or to obtain information, e.g., on pricing or delivery, please use the listed part numbers, and refer to the factory or the listed sales offices.



2-64

© 1990 Microchip Technology Inc.

. . .